

RZ/A2M Group

R01AN4500EG0100

Rev.1.0

RZ/A2M INTC Driver

Sept 19, 2018

Introduction

This application note describes the operation of the software INTC Driver for the RZ/A2 device on the RZ/A2M CPU Board.

It provides a comprehensive overview of the driver. For further details please refer to the software driver itself.

The user is assumed to have knowledge of e² studio and to be equipped with an RZ/A2M CPU Board.

Target Device

RZ/A2M Group

Driver Dependencies

This driver has no other driver dependencies.

Referenced Documents

Document Type	Document Name	Document No.
User's Manual	RZ/A2M Hardware Manual	R01UH0746EJ

List of Abbreviations and Acronyms

Abbreviation	Full Form
API	Application Programming Interface
ARM	Advanced RISC Machines
CPU	Central Processing Unit
HLD	High Layer Driver
IDE	Integrated Development Environment
INTC	Interrupt Controller
LLD	Low Layer Driver

Table 1-1 List of Abbreviations and Acronyms

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1. Outline of Software Driver

The INTC (Interrupt Controller) driver is an abstraction layer between the application and the hardware. It provides functions for enabling and disabling interrupts, setting callback functions, interrupt priorities, etc.

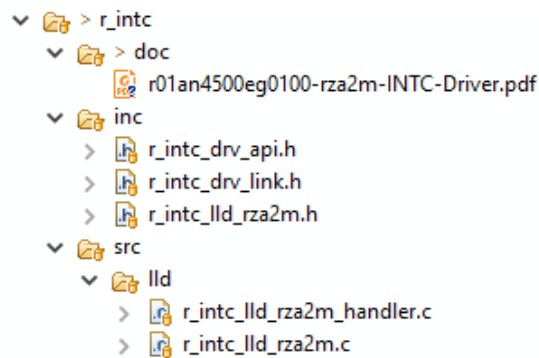
2. Description of the Software Driver

The key features of the driver include:

- Enabling and disabling interrupts
- Setting interrupt detection methods (such as level or edge triggered)
- Setting interrupt priorities
- Setting interrupt callback functions
- Masking interrupts on or off

2.1 Structure

Unlike many of the other drivers, the INTC driver currently consists of a single layer: the Low Layer Driver (LLD). This includes all the hardware specific functions and provides the API to the application.



2.2 Description of each file

Each file's description can be seen in the following table.

Filename	Usage	Description
Application-Facing Driver API		
r_intc_drv_api.h	Application	** FOR FUTURE USE **
Low Layer API		
r_intc_lld_xxxx.h	API header file	Low Layer Driver (LLD) header file (where "xxxx" is a device and board-specific identification). This is the header file to include in application code.
Abstraction Link between High and Low Layer Drivers (HLD/LLD Link)		
r_intc_drv_link.h	Private (HLD/LLD only)	** FOR FUTURE USE **
Low Layer Driver (LLD) Source		
r_intc_lld_xxxx.c	Private (LLD only)	(Where "xxxx" is a device and board specific identification). Provides the definitions for the Low Layer Driver interface.
r_intc_lld_xxxx_handler.c	Private (LLD only)	Contains Low Layer Driver interrupt handler routines

2.3 Low Layer Driver

The Low Layer Driver provides the functions to configure the hardware.

Return Type	Function	Description	Arguments	Return
e_r_drv_intc_err_t	R_INTC_Init (void)	Initialise the INTC driver	None	INTC_SUCCESS
e_r_drv_intc_err_t	R_INTC_SetNMIConfig (const st_r_drv_nmi_cfg_t * p_nmi_config)	Set NMI configuration	p_nmi_config : [in] NMI configuration (rising or falling edge)	INTC_SUCCESS
e_r_drv_intc_err_t	R_INTC_GetNMIConfig (st_r_drv_nmi_cfg_t * p_nmi_config)	Set NMI configuration	p_nmi_config : [out] NMI configuration (rising or falling edge)	INTC_SUCCESS
e_r_drv_intc_err_t	R_IRQ_Init (const st_r_drv_irq_cfg_t * p_irq_config)	Initialise IRQs (IRQ0 – IRQ7) setting interrupt detection methods	p_irq_config : [in] Interrupt detection methods	INTC_SUCCESS
e_r_drv_intc_err_t	R_TINT_Init (const st_r_drv_tint_cfg_t * p_tint_config)	Initialise TINTs (TINT0 – TINT31) setting interrupt detection methods	p_tint_config : [in] Interrupt detection methods	INTC_SUCCESS
e_r_drv_intc_err_t	R_INTC_RegisterIntFunc (e_r_drv_intc_intid_t int_id, void (* func) (uint32_t int_sense))	Register interrupt handler function	int_id : [in] interrupt ID (0 – 511) int_sense : [in] interrupt handler function	INTC_SUCCESS or INTC_ERR_INVALID ID
e_r_drv_intc_err_t	R_INTC_GetIntFunc (e_r_drv_intc_intid_t int_id, void (* func) (uint32_t int_sense))	Get the address of the interrupt handler function	int_id : [in] interrupt ID (0 – 511) int_sense : [out] interrupt handler function	INTC_SUCCESS or INTC_ERR_INVALID ID
e_r_drv_intc_err_t	R_INTC_Enable (e_r_drv_intc_intid_t int_id)	Enable an interrupt	int_id : [in] interrupt ID (0 – 511)	INTC_SUCCESS or INTC_ERR_INVALID ID
e_r_drv_intc_err_t	R_INTC_Disable (e_r_drv_intc_intid_t int_id)	Disable an interrupt	int_id : [in] interrupt ID (0 – 511)	INTC_SUCCESS or INTC_ERR_INVALID ID
e_r_drv_intc_err_t	R_INTC_SetPriority (e_r_drv_intc_intid_t int_id, e_r_drv_intc_priority_t priority)	Set an interrupt priority	int_id : [in] interrupt ID (0 – 511) priority : [in] interrupt priority	INTC_SUCCESS, INTC_ERR_INVALID ID or INTC_ERR_INVALID ID PRIORITY
e_r_drv_intc_err_t	R_INTC_GetPriority (e_r_drv_intc_intid_t int_id, e_r_drv_intc_priority_t *priority)	Get an interrupt priority	int_id : [in] interrupt ID (0 – 511) priority : [out] interrupt priority	INTC_SUCCESS, INTC_ERR_INVALID ID, INTC_ERR_INVALID ID PRIORITY or INTC_ERR_INVALID ID

e_r_drv_intc_err_t	R_INTC_SetMaskLevel (e_r_drv_intc_priority_t mask_level)	Sets the interrupt mask level	mask_level: [in] Interrupt mask level (0 - 31)	INTC_SUCCESS or INTC_ERR_INVALID_ID_PRIORITY
e_r_drv_intc_err_t	R_INTC_GetMaskLevel (e_r_drv_intc_priority_t *mask_level)	Gets the interrupt mask level	mask_level: [out] Interrupt mask level (0 - 31)	INTC_SUCCESS
e_r_drv_intc_err_t	R_IRQ_SetSense (e_r_drv_irq_num_t irq_num, e_r_drv_irq_sense_t sense)	Set IRQ pin interrupt detection method	num: [in] IRQ pin number sense: [in] interrupt detection method	INTC_SUCCESS, INTC_ERR_INVALID_ID_NUM or INTC_ERR_INVALID_ID_SENSE
e_r_drv_intc_err_t	R_IRQ_GetSense (e_r_drv_irq_num_t irq_num, e_r_drv_irq_sense_t *sense)	Get IRQ pin interrupt detection method	num: [in] IRQ pin number sense: [out] interrupt detection method	INTC_SUCCESS or INTC_ERR_INVALID_ID_NUM
e_r_drv_intc_err_t	R_INTC_GetPendingStatus (e_r_drv_intc_intid_t int_id, e_r_drv_intc_pending_t *pending_status)	Get interrupt pending state	int_id: [in] interrupt ID (0 – 511) pending_status: [out] the pending state	INTC_SUCCESS or INTC_ERR_INVALID_ID_ID
e_r_drv_intc_err_t	R_TINT_SetSense (e_r_drv_tint_num_t tint_num, e_r_drv_tint_sense_t sense)	Set the pin interrupt detection method	tint_num: [in] TINT pin number sense: [in] TINT interrupt detection method	INTC_SUCCESS, INTC_ERR_INVALID_ID_NUM or INTC_ERR_INVALID_ID_SENSE
e_r_drv_intc_err_t	R_INTC_SetIrqMask (e_r_drv_irq_mask_t mask)	Set IRQ mask	mask: [in] interrupt mask (on or off)	INTC_SUCCESS or INTC_ERR_INVALID_ID
e_r_drv_intc_err_t	R_INTC_GetIrqMask (e_r_drv_irq_mask_t *mask)	Get IRQ mask	mask: [in] interrupt mask (on or off)	INTC_SUCCESS
uint32_t	R_INTC_GetVersion (st_drv_info_t *pinfo)	Get Low Layer Driver version information	pinfo: [out] pointer to version information structure	DRV_SUCCESS

3. Example of Use

This section gives simple examples for initialising the driver, registering an interrupt callback function, setting interrupt priority, enabling an interrupt, disabling an interrupt, and finally getting the driver version.

3.1 Initialise Driver

```
e_r_drv_intc_err_t result;

result = R_INTC_Init();
```

3.2 Registering an Interrupt Callback Function

```
void MyInterruptHandler(uint32_t int_sense)
{
    /* interrupt handling code */
}

result = R_INTC_RegistIntFunc(INTC_ID_DMAC30_DMAERR0, MyInterruptHandler);
```

3.3 Setting Interrupt Priority

```
result = R_INTC_SetPriority(INTC_ID_DMAC30_DMAERR0, 28);
```

3.4 Enabling an Interrupt

```
result = R_INTC_Enable(INTC_ID_DMAC31_DMAINT9);
```

3.5 Disabling an Interrupt

```
result = R_INTC_Disable(INTC_ID_DMAC31_DMAINT9);
```

3.6 Get Version

```
st_ver_info_t info;
uint32_t get_version_result;

get_version_result = R_INTC_GetVersion(&Info);
```

4. OS Support

This driver supports any OS.

5. How to Import the Driver

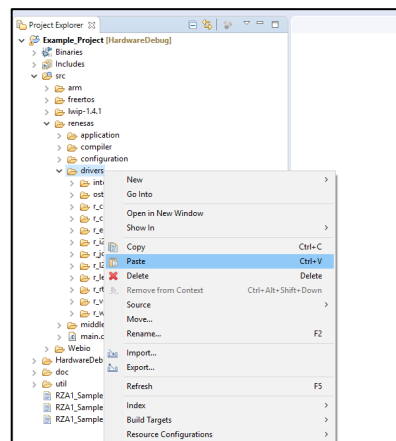
This section describes how to import the driver into your project. Generally, there are two steps in any IDE:

- 1) Copy the software driver to the location in the source tree that you require for your project.
- 2) Add the include path of the driver to the compiler.

5.1 e² studio

To import the driver into your project please follow the instructions below.

- 1) In Windows Explorer, right-click on the `r_intc` folder, and click **Copy**.
- 2) In e² studio Project Explorer view, select the folder where you wish the driver project to be located; right-click and click **Paste**.
- 3) Right-click on the parent project folder (in this case 'Example_Project') and click **Properties ...**
- 4) In 'C/C++ Build → Settings → Cross ARM Compiler → Includes', add the include folder of the newly added driver, e.g. `'${ProjDirPath}\src\renesas\drivers\r_intc\inc'`



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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Sept 19, 2018	All	Created document.

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Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

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Access to reserved addresses is prohibited.

- ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

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Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

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